Characterization of Thermally Cycled Alumina Scales

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Abstract

Cross-sectional transmission electron microscopy was used to characterize the alumina scales formed on several Ni-base alumina-formers. The alumina scale microstructure of Ni-20at%Cr-19Al-0.05Y after 100, 1h cycles at 1100°C was compared to an isothermally-grown scale. Despite being near the onset of mass loss in cyclic testing, very few defects were noted in either scale microstructure. The more adherent scales that form on Hf-doped NiAl and Ni-49at%Al-2Cr were also characterized. With the addition of Cr, the formation of $\alpha$-Cr precipitates at the metal-oxide interface coincided with increased long-term scale spallation. No similar precipitation mechanism was observed to be associated with scale spallation on NiCrAlY.

Introduction

Though not well recognized, the resistance to scale spallation of NiCrAlY-type alloys is decidedly inferior to reactive element (RE) doped $\beta$-NiAl or FeCrAlY at 1100-1200°C[1]. This fact, which has significant implications for the metallic bond coats used in thermal barrier coatings on Ni-base superalloys, is often not appreciated because the oxidation behavior of NiCrAlYs is usually evaluated at lower temperatures. Poor alumina scale adhesion leads to loss of the low thermal conductivity ceramic top coat layer[2]. One possible reason for the increased scale spallation on NiCrAlYs may simply be their higher coefficients of thermal expansion compared to $\beta$-NiAl or FeCrAlY[3-5]. However, Ni-base single-crystal superalloys have similar thermal expansion coefficients but have significantly better alumina scale adhesion without any coating[1]. This suggests that other factors may be leading to premature spallation on NiCrAlYs.

In order to investigate a possible scale microstructure-based mechanism for the poor
spallation resistance of NiCrAlYs, a direct comparison was made between isothermally and cyclically oxidized specimens exposed for the same time and temperature. Oxidation conditions were chosen so that the exposure was terminated prior to the onset of general macroscopic scale spallation (evidenced visually and by net mass losses). This strategy assumes that some type of damage in the scales will be initiated by thermal cycling but not in a similar isothermal exposure. Microscopy results for cast NiCrAlY specimens are contrasted with those for an uncoated commercial single crystal Ni-base superalloy (General Electric alloy René N5) and Hf-doped β-NiAl with and without a 2%Cr addition. The excellent oxidation performance of NiAl+Hf can be compromised when Cr is added to improve its hot corrosion resistance[6-8].

Experimental Procedure

Alloys were vacuum induction melted and cast in a 16mm diameter, water-chilled copper mold. The Ni-20Cr-19Al-0.05Y (all compositions are given in atomic%) casting was annealed for 4h at 1250°C and all other cast alloys at 1300°C. (The René N5 alloy was given a proprietary heat treatment.) Specific chemical compositions of the alloys are provided elsewhere[1,9], with nominal values provided here (specific values are provided for RE and S).

Coupons were polished to a 0.3µm alumina finish and cleaned in acetone and methanol prior to oxidation. Oxidation exposures were performed by rapid insertion into a hot furnace with a dry, flowing O₂ environment. Isothermal oxidation kinetics were measured using a Cahn model 1000 microbalance. Thermal cycles were 1h at temperature followed by 10min cooling. After exposure, characterization involved light microscopy (of Cu-plated cross sections), field-emission gun (FEG) scanning electron microscopy (SEM) and FEG transmission electron microscopy (TEM). Both electron microscopes were equipped with energy-dispersive x-ray detectors (EDS). As part of TEM specimen preparation by focused ion beam milling, a thin protective tungsten coating is deposited on the surface of the alumina scale[10].
Results and Discussion

NiCrAlY

The time-temperature exposure for examining “pre-spalled” alumina on NiCrAlY was guided by previous work suggesting that temperatures above 1100°C result in rapid scale spallation[1]. Based on long-term exposures (Figure 1), a time of 100h was selected. This time was prior to the onset of significant specimen mass losses for Ni-20Cr-19Al-0.05Y (8ppma S), and also correlated with visual observations of scale spallation. After 100h isothermal and cyclic exposures, the scales were virtually identical when viewed by light microscopy and SEM. Figure 2 shows images for the cycled specimen. The initial two-phase alloy microstructure was reflected in the Ni-rich transient oxide (Figure 2a), with little or no transient oxide over the Al-rich β phase (darker contrast) but more above the γ phase (lighter contrast). Alumina formation during the oxidation exposure led to β depletion below the scale such that the substrate near the interface is essentially single phase, Figure 2b. Periodically, Y-rich oxides formed by internal oxidation were observed. In cross-section, the alumina scale had the typical columnar structure[11-13], Figure 2c.

The similarities between the 100h isothermal and cyclic specimens also were noted by examination of TEM cross-sections. In the thin areas of the specimen, there was no evidence of any damage due to the 100 thermal cycles. Example areas are shown in Figure 3. No cracks were observed in the scale nor was there evidence of any voids, including those associated with healed cracks[14]. The only voids observed were near the gas interface and were associated with the initial, NiAl₂O₄ scale, Figure 3a. The interface between Al₂O₃ and NiAl₂O₄ is often observed to form void[15,16].

The only clear difference between the isothermal and cycled scales was the morphology of the metal-scale interface, Figure 4. The interface of the scale cycled for 100h was much rougher and somewhat less faceted than the isothermal interface. In both cases, there were slight compositional differences along the interface relative to the average composition near the
interface, with Cr slightly depleted and Al enriched at “peaks” and Cr slightly enriched at “valleys”, Figure 4. However, these compositional changes were at most 1 at% and did not appear to include any phase precipitation. In both cases, Y ions were found to segregate to the alumina scale grain boundaries and the metal-oxide interface, as has been observed in many other alumina scales\[9,12,17-23\]. Cycling did not appear to affect segregation. Because of the short time and relatively low temperature, no Y-rich oxides had precipitated in the scale\[22,23\].

Based on the mass losses that occur after 150, 1h cycles (Figure 1), it is somewhat surprising that there was no indication of future failure after 100, 1h cycles. However, when examining the specimens after 100h by SEM, localized areas were found that had already spalled after both isothermal and cyclic exposures, Figure 5a. Because both specimens spalled, this indicates that the interface roughening observed under thermal cycling (Figure 4) was not a primary factor in this localized scale spallation. However, it is possible that defects which lead to scale failure were confined to these localized spallation areas. If so, the unspalled oxide, which is what remains to be characterized, would not contain any incipient defects.

Isothermal and cyclic specimens were also examined after 200h at 1100°C. However, at this stage there was significant spallation on both specimens making TEM preparation difficult. One interesting observation on the cycled specimen was the presence of a few smooth regions on the metal substrate exposed by scale spallation, Figure 5b, that appeared to correspond to interfacial voids\[24,25,26\]. While such voids develop during oxidation of undoped FeCrAl \[10,11\] or NiAl \[18,24,25\], they generally have not been observed on NiCrAl\[1,27\]. However, the number of voids was far fewer than normally observed on undoped NiAl \[24\].

While in principle the comparison of isothermally and cyclically formed oxides may be a good experimental approach, in this case, it did not prove useful in determining a mechanism for scale spallation on NiCrAlY. The absence of defects in either scale may indicate either that damage accumulation does not occur in scales or, as mentioned above, that damage does not aggregate uniformly in the scale but is highly localized. However, it could also indicate that the
minimum flaw size that will initiate a crack leading to scale failure is very small, such that, when any defect nucleates, a crack propagates and spallation results at that location. In any of these cases, characterization of the remaining intact scale would not reveal incipient defects.

Several other NiCrAlY compositions with differing Cr and Al contents were also considered, Figure 1. However, because their resistance to scale spallation was not significantly better, microstructure comparisons instead were made with alumina scales formed on more spallation-resistant alloys.

**Monocrystal superalloy: René N5**

Compared to NiCrAlY, the cyclic oxidation performance of uncoated General Electric alloy René N5 (Ni-14Al-8Cr-7Co-2Ta-2W-1Re-1Mo-0.05Hf-0.05Y-7ppma S) is fairly good at 1100°C, Figure 1. No severe scale spallation was observed until after 1000h [28]. The somewhat erratic mass change (Figure 1) is likely due to the spallation of the outer, Ni-rich transient layer which forms due to its lower Cr and Al contents [28]. After a 100h isothermal exposure at 1100°C, this layer was ≈500nm thick and contained Ni, Co, Cr and Al, Figure 6. At the transient oxide-alumina interface, numerous Ta-rich oxide particles were observed, as has been noted previously [9,29]. The underlying alumina layer showed no defects and was similar to that formed on NiCrAlY except that the column width (≈0.3µm average) was somewhat smaller than that on NiCrAlY (≈0.4µm average). Both Hf and Ta ions, but not Y, were found segregated to the alumina scale grain boundaries and the metal-scale interface. Due to the low Y content of the alloy (≈50ppm), Y segregation may be difficult to detect in this case. Previous work on scales grown on René N5 at 1200°C, did detect Y ion segregation [9].

The comparable 100h cyclic specimen was not evaluated. However, because of its superior oxidation performance (Figure 1), it was not likely to show significant damage after only a 100 cycle exposure.

The fact that the very strong René N5 substrate performs better than the weak NiCrAlY substrate (Figure 1) does not fit a proposed spallation model based on substrate creep response
Both alloys contain similar amounts of sulfur (NiCrAlY, 8ppma vs. René N5, 7ppma), therefore, any detrimental effect of sulfur cannot explain the difference in their performance. One possible factor which may contribute to the improved performance of René N5 relative to NiCrAlY is the presence of both Hf and Y. The low solubility of Y leads to the formation of NiY<sub>x</sub> compounds, which are subject to internal oxidation and associated local scale spallation [31]. Hence the combination of a low level of Y with some Hf (which is more soluble than Y) may be beneficial. Another possibility is that the Ni-20Cr-19Al-0.05Y alloy does not contain sufficient Y but that does not appear likely, based on studies of higher Y levels in cast NiCrAlY [1]. Higher Y contents simply generate more internal oxide, which initiates more scale spallation.

NiAl+Hf

An additional comparison was made with the scale formed on Hf-doped NiAl (Ni-50Al-0.05Hf, <4ppma S), which is the most spallation-resistant alumina-forming substrate studied at this laboratory. Whereas the goal is to improve the oxidation performance of NiCrAlY, the optimized composition of NiAl+0.05%Hf generally is modified in order to examine how various additives degrade its oxidation performance.

The alumina scale on NiAl+Hf is somewhat different than that formed on NiCrAlY. Due to the addition of Hf, the steady-state isothermal scale growth rate at 1100°C is reduced to 1.1 x 10<sup>-13</sup> g<sup>2</sup>cm<sup>4</sup>/s compared to 12-15 x 10<sup>-13</sup> g<sup>2</sup>cm<sup>4</sup>/s for NiCrAlY. This is reflected in lower cyclic weight changes, Figure 1, and a thinner scale, Figure 7a. With the thinner oxide, the columnar structure is less evident, with the scale only one grain thick and the grains being similar in width and height. One interesting feature is that, although the entire scale is α-Al<sub>2</sub>O<sub>3</sub>, the outer layer contains numerous voids, while the inner scale is virtually void free, Figure 7b. This voidage appears to mark the boundary between oxide which has transformed from cubic alumina (with the associated volume reduction creating the voids [32]) and oxide which grew as α phase. Based on a measured decrease in the scale growth rate, this transformation is complete by approximately 10h at 1100°C and qualitatively corresponds to the observed thickness ratio of the
void-containing layer to the total scale thickness.

Another interesting feature observed in the scale was a metal protrusion with an extremely thin overlying alumina layer, Figure 8a. An oxide grain above the protrusion appears to be misoriented such that there is no perpendicular grain boundary above the metal that would allow oxygen boundary transport and supply the reactant to form alumina. Rather than a deformation of the substrate, the protrusion appeared to form due to a local disruption in the normal diffusion through the scale. Metal protrusions have been observed in other alumina-forming systems [33,34]. With the overlying oxide being approximately the thickness of the transformed (void-containing) oxide, the misoriented grain may remain from initial, random nucleation of \( \alpha \)-Al\(_2\)O\(_3\) grains at the metal-scale interface [35,36].

Throughout the cross-section, Hf ions are found to segregate to the oxide grain boundaries and the metal-scale interface. An example is given in Figure 8b.

Despite all of the interesting observations in the cyclically-formed scale on Hf-doped NiAl, there is no clear reason from a scale microstructure standpoint for the improved oxidation performance of Hf-doped NiAl compared to NiCrAlY. As observed in the scale on NiCrAlY, fine voids near the gas interface had no negative effect and no other defects were observed in the scale.

**NiAl+2Cr+Hf**

One limitation of Hf-doped NiAl is that, due to the absence of Cr [37], it has poor hot corrosion resistance. Additions of Cr have been made to NiAl in an attempt to improve its hot corrosion resistance [6,8]. However, as shown in Figure 1, even 2%Cr (Ni-49.6Al-2Cr-0.05Hf, 4ppm S) had a decidedly negative effect by accelerating the scale formation rate relative to NiAl+Hf. At higher temperatures (1200°C), this addition of Cr also eventually results in increased scale spallation compared to NiAl+Hf [8] and negative effects have been noted previously [38]. Characterization of the scale formed on Hf-doped NiAl-2Cr showed that after 2h at 1200°C, small Cr precipitates began to form at the metal-scale interface, Figure 9. These precipitates presumably formed due to the rejection of Cr from the growing scale and the low
solubility of Cr in the $\beta$ matrix. It is suggested that these interfacial $\alpha$ precipitates will grow with increased exposure time and ultimately lead to spallation of the alumina scale, either due to their different coefficient of thermal expansion ($10 \times 10^{-6}$ compared to $15 \times 10^{-6}$ K$^{-1}$ for $\beta$ [5,39]) or by reduced adhesion to the overlying alumina scale. However, it is not clear at this time why the addition of Cr accelerates the cyclic mass gain at 1100°C, Figure 1. Similar small $\alpha$ precipitates have been observed in simple and Pt-modified aluminide coatings [40,41].

While $\alpha$-Cr precipitation appears to be a probable scale failure mechanism for Hf-doped NiAl-Cr, it does not appear likely for NiCrAlY. Significant Cr solubility in the $\gamma$ phase of NiCrAlY should preclude $\alpha$ precipitation and initial characterization did not detect the presence of $\alpha$ precipitates at the metal-scale interface in NiCrAlY.

Summary

The scale on 100h, 1100°C isothermally and cyclically-exposed Ni-20Cr-19Al-0.05Y specimens was examined in order to look for incipient damage in the alumina scale and provide a microstructural explanation for its poor performance in cyclic testing. However, only minimal differences were noted between the two microstructures with no evidence of increased defect formation in the thermally cycled scale. Analyses of alumina scales formed on René N5 and $\beta$-NiAl+Hf also showed no significant damage in the alumina scale. When Cr is added to NiAl+Hf, oxidation performance is degraded and $\alpha$-Cr precipitates are observed at the metal-scale interface. These precipitates may lead to scale spallation for NiAl. However, in the case of NiCrAlY, they would not be expected to form and were not observed.

Acknowledgments

The authors are thankful to G. Garner and L. D. Chitwood for assistance with the oxidation work, T. Geer for metallography and K. S. Trent and D. Coffey for TEM-FIB specimen
preparation and M. Lance, M. Brady and J. DiStefano for comments on the manuscript. The research was sponsored by the Fossil Energy Advanced Research and Technology Development (AR&TD) Materials Program, and the Advanced Turbine Systems Program, U. S. Department of Energy, under contract DE-AC05-96OR22464 with Lockheed Martin Energy Research Corp.

References


Figure Captions

Figure 1. Mass changes during 1h cycles at 1100°C in dry flowing O₂ for various NiCrAl and NiAl alloys.

Figure 2. Scale on Ni-20Cr-19Al-0.05Y after 100, 1h cycles at 1100°C, (a) SEM bright field plan view of surface oxide, (b) light microscopy of metallographic cross-section showing two phases and internal oxidation of Y (large arrow) and (c) SEM bright field cross-section of alumina scale.

Figure 3. TEM bright field images of alumina scale formed on Ni-20Cr-19Al-0.05Y at 1100°C after (a) 100, 1h cycles and (b) 100h isothermal. Both have a columnar structure with voids (arrows) only near the gas interface and no cracks.

Figure 4. TEM bright field images of alumina scale formed on Ni-20Cr-19Al-0.05Y at 1100°C after (a) 100, 1h cycles and (b) 100h isothermal. The isothermal interface is more faceted and geometric than the cycled interface.

Figure 5. SEM secondary electron plan-view images of Ni-20Cr-19Al-0.05Y oxidized at 1100°C: (a) spalled regions after 100h isothermal and (b) exposed metal in spalled region after 200, 1h cycles. In both cases spallation is to bare metal, in (b) the smooth regions appear to correspond to an interfacial void.

Figure 6. TEM bright field image of the scale formed on René N5 after 100h at 1100°C. A thicker Ni-rich transient oxide forms on this alloy due to its low Cr and Al content and Ta-rich precipitates (arrows) are observed at the alumina-transient oxide interface.

Figure 7. TEM bright field images of the alumina scale formed on Hf-doped NiAl after 100, 1h cycles at 1100°C. At higher magnification (b), there is a clear division between the outer scale containing voids and the lower, denser oxide.

Figure 8. (a) TEM bright field image of the scale formed on NiAl+Hf after 100, 1h cycles at 1100°C (b) Hf EDS x-ray map from box in (a) shows segregation of Hf ions at oxide grain boundary and at metal-oxide interface. Center of (a) shows a metal protrusion into the scale with a misoriented alumina grain above (arrow).

Figure 9. (a) TEM bright field image of the alumina scale formed on Ni-49Al-2Cr+Hf after 2h at 1200°C; (b) Cr EDS X-ray map at the interface reveals Cr-rich precipitates (arrows) in the metal adjacent to the metal-scale interface.
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